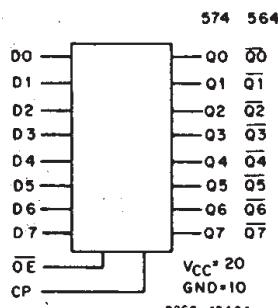




Data sheet acquired from Harris Semiconductor
SCHS292

Technical Data

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574



FUNCTIONAL DIAGRAM

Octal D-Type Flip-Flop, 3-State Positive-Edge-Triggered

CD54/74AC/ACT564 - Inverting
CD54/74AC/ACT574 - Non-Inverting

Type Features:

- *Buffered inputs*
- *Typical propagation delay:
6.5 ns @ V_{cc} = 5 V, T_A = 25°C, C_L = 50 pF*

The RCA-CD54/74AC564 and CD54/74AC574 and the CD54/74ACT564 and CD54/74ACT574 octal D-type, 3-state, positive-edge-triggered flip-flops use the RCA ADVANCED CMOS technology. The eight flip-flops enter data into their registers on the LOW-to-HIGH transition of the clock (CP). The Output Enable (OE) controls the 3-state outputs and is independent of the register operation. When the Output Enable (\overline{OE}) is HIGH, the outputs are in the high-impedance state. The CD54/74AC/ACT564 and CD54/74AC/ACT574 share the same pin configurations; the CD54/74AC/ACT564, however, has inverted outputs and the CD54/74AC/ACT574 has non-inverted outputs.

The CD74AC/ACT564 and CD74AC/ACT574 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead-dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC/ACT564 and CD54AC/ACT574, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

Family Features:

- *Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015*
- *SCR-Latchup-resistant CMOS process and circuit design*
- *Speed of bipolar FAST®/AS/S with significantly reduced power consumption*
- *Balanced propagation delays*
- *AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply*
- *± 24-mA output drive current*
 - *Fanout to 15 FAST® ICs*
 - *Drives 50-ohm transmission lines*

*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

TRUTH TABLE

| INPUTS | | | OUTPUTS | |
|--------|----|----|------------------|-----|
| | | | 564 | 574 |
| OE | CP | Dn | \overline{Q}_n | Qn |
| L | — | H | L | H |
| L | — | L | H | L |
| L | L | X | \overline{Q}_0 | Q0 |
| H | X | X | Z | Z |

9

H = High level (steady state)

L = Low level (steady state)

X = Don't care

— = Transition from low to high level

Q0 = The level of Q before the indicated steady-state input conditions were established

\overline{Q}_0 = The level of \overline{Q} before the indicated steady-state input conditions were established.

Z = High impedance

This data sheet is applicable to the CD54/74AC574 and CD54/74ACT574. The CD54/74AC564 and CD54/74ACT564 were not acquired from Harris Semiconductor.

File Number 1948

Technical Data

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

MAXIMUM RATINGS, Absolute-Maximum Values:

| | |
|---|--------------------------------------|
| DC SUPPLY-VOLTAGE (V _{cc}) | -0.5 to 6 V |
| DC INPUT DIODE CURRENT, I _{IN} (for V _I < -0.5 V or V _I > V _{cc} + 0.5 V) | ±20 mA |
| DC OUTPUT DIODE CURRENT, I _{ox} (for V _O < -0.5 V or V _O > V _{cc} + 0.5 V) | ±50 mA |
| DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, I _O (for V _O > -0.5 V or V _O < V _{cc} + 0.5 V) | ±50 mA |
| DC V _{cc} or GROUND CURRENT (I _{cc} or I _{GND}) | ±100 mA* |
| POWER DISSIPATION PER PACKAGE (P _D): | |
| For T _A = -55 to +100°C (PACKAGE TYPE E) | 500 mW |
| For T _A = +100 to +125°C (PACKAGE TYPE E) | Derate Linearly at 8 mW/°C to 300 mW |
| For T _A = -55 to +70°C (PACKAGE TYPE M) | 400 mW |
| For T _A = +70 to +125°C (PACKAGE TYPE M) | Derate Linearly at 6 mW/°C to 70 mW |
| OPERATING-TEMPERATURE RANGE (T _A): | -55 to +125°C |
| STORAGE TEMPERATURE (T _{stg}): | -65 to +150°C |
| LEAD TEMPERATURE (DURING SOLDERING): | |
| At distance 1/16 ± 1/32 in. (1.59 ± 0.79 mm) from case for 10 s maximum | +265°C |
| Unit inserted into PC board min. thickness 1/16 in. (1.59 mm) with solder contacting lead tips only | +300°C |

*For up to 4 outputs per device; add ± 25 mA for each additional output.

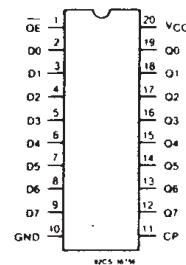
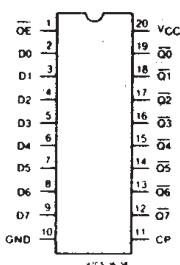
RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC | LIMITS | | UNITS |
|---|--------|-----------------|-------|
| | MIN. | MAX. | |
| Supply-Voltage Range, V _{cc} *: (For T _A = Full Package-Temperature Range) | | | |
| AC Types | 1.5 | 5.5 | V |
| ACT Types | 4.5 | 5.5 | V |
| DC Input or Output Voltage, V _I , V _O | 0 | V _{cc} | V |
| Operating Temperature, T _A | -55 | +125 | °C |
| Input Rise and Fall Slew Rate, dt/dv | | | |
| at 1.5 V to 3 V (AC Types) | 0 | 50 | ns/V |
| at 3.6 V to 5.5 V (AC Types) | 0 | 20 | ns/V |
| at 4.5 V to 5.5 V (ACT Types) | 0 | 10 | ns/V |

*Unless otherwise specified, all voltages are referenced to ground.

TERMINAL ASSIGNMENT DIAGRAMS



CD54/74AC/ACT564

CD54/74AC/ACT574

**CD54/74AC564, CD54/74AC574
CD54/74ACT564, CD54/74ACT574**

STATIC ELECTRICAL CHARACTERISTICS: AC Series

| CHARACTERISTICS | TEST CONDITIONS | | V _{CC} (V) | AMBIENT TEMPERATURE (T _A) - °C | | | | | | UNITS | |
|-------------------------------|-----------------------|--|------------------------|--|------|------------|------|-------------|------|-------|----|
| | | | | +25 | | -40 to +85 | | -55 to +125 | | | |
| | V _I (V) | I _O (mA) | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | | |
| High-Level Input Voltage | V _{IH} | | 1.5 | 1.2 | — | 1.2 | — | 1.2 | — | V | |
| | | | 3 | 2.1 | — | 2.1 | — | 2.1 | — | | |
| | | | 5.5 | 3.85 | — | 3.85 | — | 3.85 | — | | |
| Low-Level Input Voltage | V _{IL} | | 1.5 | — | 0.3 | — | 0.3 | — | 0.3 | V | |
| | | | 3 | — | 0.9 | — | 0.9 | — | 0.9 | | |
| | | | 5.5 | — | 1.65 | — | 1.65 | — | 1.65 | | |
| High-Level Output Voltage | V _{OH} | V _{IH} or V _{IL} #,* { | -0.05 | 1.5 | 1.4 | — | 1.4 | — | 1.4 | V | |
| | | | -0.05 | 3 | 2.9 | — | 2.9 | — | 2.9 | | |
| | | | -0.05 | 4.5 | 4.4 | — | 4.4 | — | 4.4 | | |
| | | | -4 | 3 | 2.58 | — | 2.48 | — | 2.4 | | |
| | | | -24 | 4.5 | 3.94 | — | 3.8 | — | 3.7 | | |
| | | | -75 | 5.5 | — | — | 3.85 | — | — | | |
| | | | -50 | 5.5 | — | — | — | — | 3.85 | | |
| Low-Level Output Voltage | V _{OL} | V _{IH} or V _{IL} #,* { | 0.05 | 1.5 | — | 0.1 | — | 0.1 | — | V | |
| | | | 0.05 | 3 | — | 0.1 | — | 0.1 | — | | |
| | | | 0.05 | 4.5 | — | 0.1 | — | 0.1 | — | | |
| | | | 12 | 3 | — | 0.36 | — | 0.44 | — | | |
| | | | 24 | 4.5 | — | 0.36 | — | 0.44 | — | | |
| | | | 75 | 5.5 | — | — | — | 1.65 | — | | |
| | | | 50 | 5.5 | — | — | — | — | 1.65 | | |
| Input Leakage Current | I _I | V _{CC} or GND | 5.5 | — | ±0.1 | — | ±1 | — | ±1 | μA | |
| 3-State Leakage Current | I _{OZ} | V _{IH} or V _{IL} Vo = V _{CC} or GND | 5.5 | — | ±0.5 | — | ±5 | — | ±10 | μA | |
| Quiescent Supply Current, MSI | I _{CC} | V _{CC} or GND | 0 | 5.5 | — | 8 | — | 80 | — | 160 | μA |

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C. 75 ohms at +125°C.

Technical Data

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

STATIC ELECTRICAL CHARACTERISTICS: ACT Series

| CHARACTERISTICS | TEST CONDITIONS | | V _{CC} (V) | AMBIENT TEMPERATURE (T _A) - °C | | | | | | UNITS | | |
|---|-----------------------|---|---|--|------|------------|------|-------------|------|-------|----|--|
| | V _I (V) | I _O (mA) | | +25 | | -40 to +85 | | -55 to +125 | | | | |
| | | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | | | |
| High-Level Input Voltage | V _{IH} | | 4.5 to 5.5 | 2 | — | 2 | — | 2 | — | V | | |
| Low-Level Input Voltage | V _{IL} | | 4.5 to 5.5 | — | 0.8 | — | 0.8 | — | 0.8 | V | | |
| High-Level Output Voltage | V _{OH} | V _{IH} or V _{IL} #, * | -0.05 4.5 4.4 — 4.4 — 4.4 — -24 4.5 3.94 — 3.8 — 3.7 — -75 5.5 — — 3.85 — — — -50 5.5 — — — — 3.85 — | | | | | | | V | | |
| Low-Level Output Voltage | V _{OL} | V _{IH} or V _{IL} #, * | 0.05 4.5 — ±0.1 — ±.1 — ±.1 24 4.5 — 0.36 — 0.44 — 0.5 75 5.5 — — — 1.65 — — 50 5.5 — — — — — 1.65 | | | | | | | V | | |
| Input Leakage Current | I _I | V _{CC} or GND | 5.5 | — | ±0.1 | — | ±1 | — | ±1 | μA | | |
| 3-State Leakage Current | I _{OZ} | V _{IH} or V _{IL} V _O = V _{CC} or GND | 5.5 | — | ±0.5 | — | ±5 | — | ±10 | μA | | |
| Quiescent Supply Current, MSI | I _{CC} | V _{CC} or GND | 0 | 5.5 | — | 8 | — | 80 | — | 160 | μA | |
| Additional Quiescent Supply Current per Input Pin TTL Inputs High 1 Unit Load | ΔI _{CC} | V _{CC} -2.1 | | 4.5 to 5.5 | — | 2.4 | — | 2.8 | — | 3 | mA | |

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

ACT INPUT LOADING TABLE

| INPUT | UNIT LOADS* |
|-------------|-------------|
| D, OE CP | 0.7 1.17 |

*Unit load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

PREREQUISITE FOR SWITCHING: AC Series

| CHARACTERISTICS | SYMBOL | V_{CC} (V) | AMBIENT TEMPERATURE (T_A) -°C | | | | UNITS | |
|--------------------------|-----------|----------------------------|-----------------------------------|-------------|-----------------|-------------|-------|--|
| | | | -40 to +85 | | -55 to +125 | | | |
| | | | MIN. | MAX. | MIN. | MAX. | | |
| Clock Pulse Width | t_W | 1.5 3.3* \dagger 5 | 44 4.9 3.5 | — — — | 50 5.6 4 | — — — | ns | |
| Setup Time Data to Clock | t_{SU} | 1.5 3.3 5 | 2 2 2 | — — — | 2 2 2 | — — — | ns | |
| Hold Time Data to Clock | t_H | 1.5 3.3 5 | 2 2 2 | — — — | 2 2 2 | — — — | ns | |
| Maximum Clock Frequency | f_{MAX} | 1.5 3.3 5 | 11 101 143 | — — — | 10 89 125 | — — — | MHz | |

*3.3 V: min. is @ 3 V

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: AC Series; $t_i, t_o = 3$ ns, $C_L = 50 \mu F$

| CHARACTERISTICS | SYMBOL | V_{CC} (V) | AMBIENT TEMPERATURE (T_A) -°C | | | | UNITS | | |
|--|-------------------------------------|-----------------------------------|-----------------------------------|---------------------|-----------------|---------------------|-------|--|--|
| | | | -40 to +85 | | -55 to +125 | | | | |
| | | | MIN. | MAX. | MIN. | MAX. | | | |
| Propagation Delays: Clock to Q AC574 | t_{PLH} t_{PHL} t_{PHL} | 1.5 3.3* \dagger 5 2.9 | — 4 2.9 | 123 13.7 9.8 | — 3.8 2.7 | 135 15.1 10.8 | ns | | |
| Clock to \bar{Q} AC564 | t_{PLH} t_{PHL} | 1.5 3.3 5 | — 4.1 2.9 | 128 14.4 10.3 | — 4 2.8 | 141 15.8 11.3 | ns | | |
| Output Enable to Q, \bar{Q} | t_{PZL} t_{PZH} | 1.5 3.3 5 | — 5.6 3.7 | 165 19.2 13.2 | — 5.5 3.6 | 181 21.8 14.5 | ns | | |
| Output Disable to Q, \bar{Q} | t_{PLZ} t_{PHZ} | 1.5 3.3 5 | — 4.7 3.7 | 165 16.5 13.2 | — 4.5 3.6 | 181 18.1 14.5 | ns | | |
| Power Dissipation Capacitance | $C_{PD\$}$ | — | 67 Typ. | | 67 Typ. | | pF | | |
| Min. (Valley) V_{OH} During Switching of Other Outputs (Output Under Test Not Switching) | V_{OHV} See Fig. 1 | 5 | 4 Typ. @ 25°C | | | | V | | |
| Max. (Peak) V_{OL} During Switching of Other Outputs (Output Under Test Not Switching) | V_{OLP} See Fig. 1 | 5 | 1 Typ. @ 25°C | | | | V | | |
| Input Capacitance | C_I | — | — | 10 | — | 10 | pF | | |
| 3-State Output Capacitance | C_O | — | — | 15 | — | 15 | pF | | |

*3.3 V: min. is @ 3.6 V
max. is @ 3 V†5 V: min. is @ 5.5 V
max. is @ 4.5 V§ C_{PD} is used to determine the dynamic power consumption, per flip flop.

$$P_D = C_{PD} V_{CC}^2 f_i + \sum V_{CC}^2 f_o C_L \text{ where } f_i = \text{input frequency}$$

 $f_o = \text{output frequency}$ $C_L = \text{output load capacitance}$ $V_{CC} = \text{supply voltage}$

Technical Data

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

PREREQUISITE FOR SWITCHING: ACT Series

| CHARACTERISTICS | SYMBOL | V_{CC} (V) | AMBIENT TEMPERATURE (T_A) -°C | | | | UNITS | |
|--------------------------|-----------|-----------------|-----------------------------------|------|-------------|------|-------|--|
| | | | -40 to +85 | | -55 to +125 | | | |
| | | | MIN. | MAX. | MIN. | MAX. | | |
| Clock Pulse Width | t_w | 5† | 3.9 | — | 4.5 | — | ns | |
| Setup Time Data to Clock | t_{SU} | 5 | 2 | — | 2 | — | ns | |
| Hold Time Data to Clock | t_H | 5 | 2.6 | — | 3 | — | ns | |
| Maximum Clock Frequency | f_{MAX} | 5 | 125 | — | 110 | — | MHz | |

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: ACT Series; $t_s, t_i = 3$ ns, $C_L = 50$ pF

| CHARACTERISTICS | SYMBOL | V_{CC} (V) | AMBIENT TEMPERATURE (T_A) -°C | | | | UNITS | | |
|--|--|-----------------|-----------------------------------|------|-------------|------|-------|--|--|
| | | | -40 to +85 | | -55 to +125 | | | | |
| | | | MIN. | MAX. | MIN. | MAX. | | | |
| Propagation Delays: Clock to Q ACT574 | t_{PLH} t_{PHL} | 5† | 2.9 | 10.2 | 2.8 | 11.2 | ns | | |
| Clock to \bar{Q} ACT564 | t_{PLH} t_{PHL} | 5 | 3 | 10.6 | 2.9 | 11.7 | ns | | |
| Output Enable and Disable to Q ACT574 | t_{PLZ} t_{PHZ} t_{PZL} t_{PZH} | 5 | 3.7 | 13.2 | 3.6 | 14.5 | ns | | |
| Output Enable and Disable to \bar{Q} ACT564 | t_{PLZ} t_{PHZ} t_{PZL} t_{PZH} | 5 | 3.7 | 13.2 | 3.6 | 14.5 | ns | | |
| Power Dissipation Capacitance | $C_{PD\$}$ | — | 67 Typ. | | 67 Typ. | | pF | | |
| Min. (Valley) V_{OH} During Switching of Other Outputs (Output Under Test Not Switching) | V_{OHV} See Fig. 1 | 5 | 4 Typ. @ 25°C | | | | V | | |
| Max. (Peak) V_{OL} During Switching of Other Outputs (Output Under Test Not Switching) | V_{OLP} See Fig. 1 | 5 | 1 Typ. @ 25°C | | | | V | | |
| Input Capacitance | C_I | — | — | 10 | — | 10 | pF | | |
| 3-State Output Capacitance | C_O | — | — | 15 | — | 15 | pF | | |

†5 V: min. is @ 5.5 V
max. is @ 4.5 V

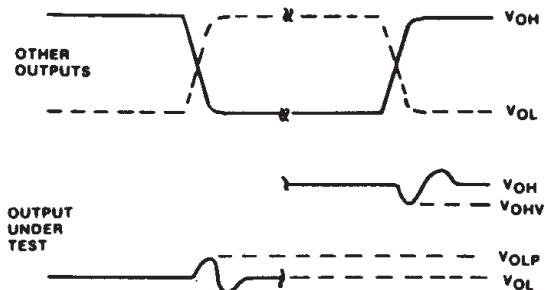
§ C_{PD} is used to determine the dynamic power consumption, per flip flop.

$$P_D = C_{PD} V_{CC}^2 f_i + \sum V_{CC}^2 f_o C_L + V_{CC} \Delta I_{CC}$$

where f_i = input frequency
 f_o = output frequency
 C_L = output load capacitance
 V_{CC} = supply voltage.

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

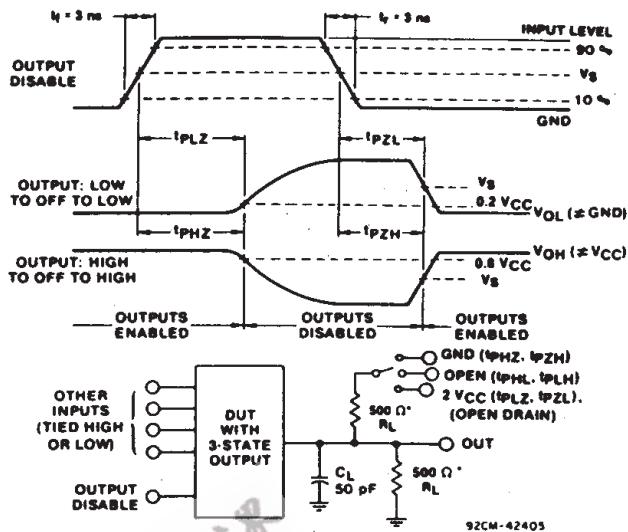
PARAMETER MEASUREMENT INFORMATION



NOTES:

1. V_{OH} AND V_{OLP} ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:
 $PRR \leq 1 \text{ MHz}$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$, SKEW 1 ns.
3. R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED.
IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH 0.1 μF CAPACITOR. SCOPE AND PROBES REQUIRE 700-MHz BANDWIDTH.

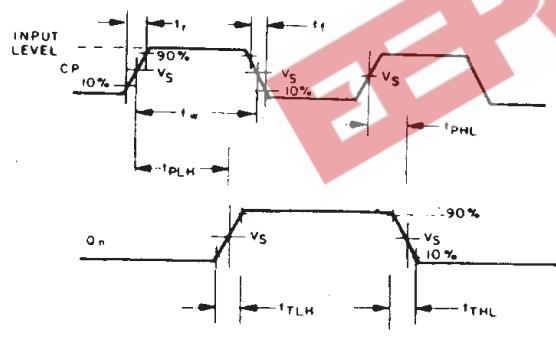
92CS-42406

*FOR AC SERIES ONLY: WHEN $V_{CC} = 1.5 \text{ V}$, $R_L = 1 \text{ k}\Omega$

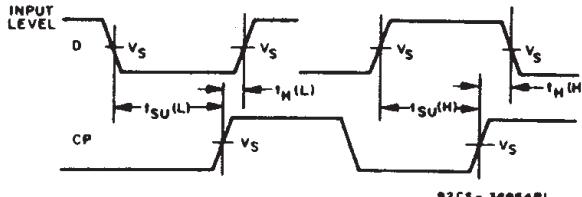
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Fig. 1 - Simultaneous switching transient waveforms.

Fig. 2 - Three-state propagation delay waveforms and test circuit.

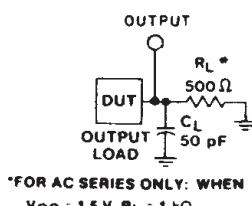


92CS-36404RI



92CS-36954RI

9

*FOR AC SERIES ONLY: WHEN
 $V_{CC} = 1.5 \text{ V}$, $R_L = 1 \text{ k}\Omega$

92CS-42189

| | CD54/74AC | CD54/74ACT |
|---------------------------------|--------------|--------------|
| Input Level | V_{CC} | 3 V |
| Input Switching Voltage, V_S | 0.5 V_{CC} | 1.5 V |
| Output Switching Voltage, V_S | 0.5 V_{CC} | 0.5 V_{CC} |

Fig. 3 - Propagation delays times and test circuit.

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